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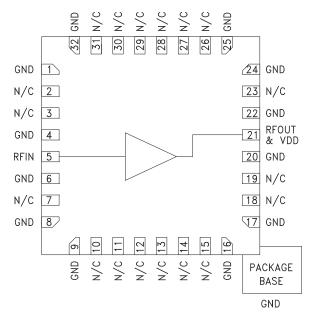
ROHS

Typical Applications

The HMC907LP5E is ideal for:

- Test Instrumentation
- Microwave Radio & VSAT
- Military & Space
- Telecom Infrastructure
- Fiber Optics

Functional Diagram



HMC907LP5E

GaAs pHEMT MMIC POWER AMPLIFIER, 0.2 - 22 GHz

Features

High P1dB Output Power: +26 dBm High Gain: 12 dB High Output IP3: +36 dBm Single Supply: +10 V @ 350 mA 50 Ohm Matched Input/Output 32 Lead 5x5 mm SMT Package: 25 mm²

General Description

The HMC907LP5E is a GaAs MMIC pHEMT Distributed Power Amplifier which operates between 0.2 and 22 GHz. This self-biased power amplifier provides 12 dB of gain, +36 dBm output IP3 and +26 dBm of output power at 1 dB gain compression while requiring only 350 mA from a +10 V supply. Gain flatness is excellent at ±0.7 dB from 0.2 to 22 GHz making the HMC907LP5E ideal for EW, ECM, Radar and test equipment applications. The HMC907LP5E amplifier I/Os are internally matched to 50 Ohms facilitating integration into Mutli-Chip-Modules (MCMs) and is packaged in a leadless QFN 5x5 mm surface mount package, and requires no external matching components.

Electrical Specifications, $T_A = +25 \text{ °C}$, Vdd = +10 V, Idd = 350 mA

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range		0.2 - 10			10 - 18			18 - 22		GHz
Gain	10	12		10	11.5		10	11.5		dB
Gain Flatness		±0.7			±0.6			±0.7		dB
Gain Variation Over Temperature		0.01			0.013			0.014		dB/ °C
Input Return Loss		15			9			8		dB
Output Return Loss		13			12			8		dB
Output Power for 1 dB Compression (P1dB)	23	26		21	25		19.5	21.5		dBm
Saturated Output Power (Psat)		28.5			27			24.5		dBm
Output Third Order Intercept (IP3)		36			34			31		dBm
Noise Figure		3.5			3.5			4		dB
Supply Current (Idd) (Vdd= 10V)		350	400		350	400		350	400	mA

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HMC907* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

COMPARABLE PARTS

View a parametric search of comparable parts.

EVALUATION KITS

HMC907LP5E Evaluation Board

DOCUMENTATION

Data Sheet

- HMC907 Die Data Sheet
- HMC907LP5E Data Sheet

TOOLS AND SIMULATIONS \square

- HMC907 Die S-Parameters
- HMC907LP5E S-Parameters

REFERENCE MATERIALS

Quality Documentation

- Package/Assembly Qualification Test Report: 32L 5x5mm QFN Package (QTR: 10009 REV: 05)
- Package/Assembly Qualification Test Report: LP5 & LP5G (QTR: 2014-00150 REV: 02)
- Semiconductor Qualification Test Report: PHEMT-H (QTR: 2013-00260)

DESIGN RESOURCES

- HMC907 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

View all HMC907 EngineerZone Discussions.

SAMPLE AND BUY

Visit the product page to see pricing options.

TECHNICAL SUPPORT

Submit a technical question or find your regional support number.

DOCUMENT FEEDBACK

Submit feedback for this data sheet.

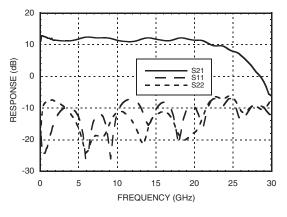


GaAs pHEMT MMIC

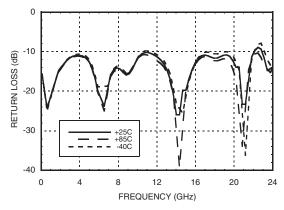
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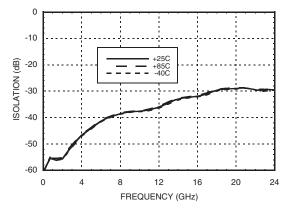
Gain & Return Loss



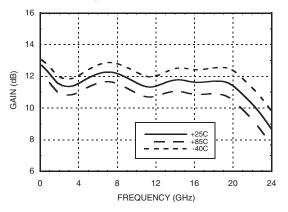
Input Return Loss vs. Temperature



Reverse Isolation vs. Temperature

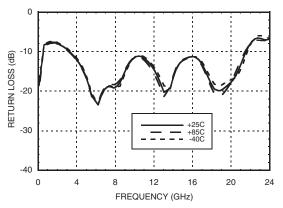


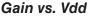
Gain vs. Temperature

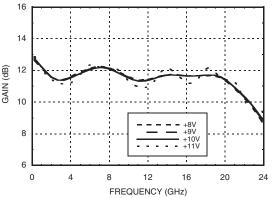


POWER AMPLIFIER, 0.2 - 22 GHz

Output Return Loss vs. Temperature







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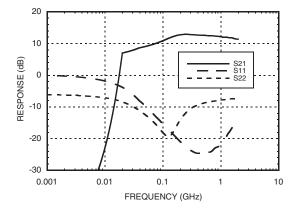


GaAs pHEMT MMIC

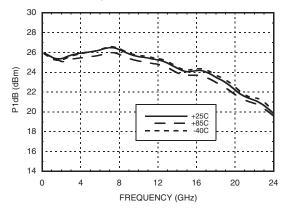
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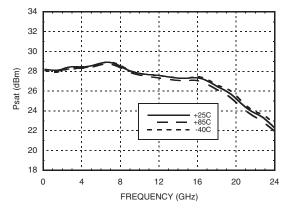
Low Frequency Gain & Return Loss



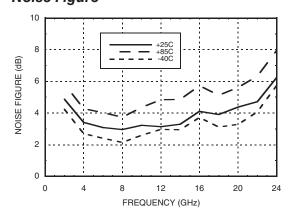
P1dB vs. Temperature



Psat vs. Temperature

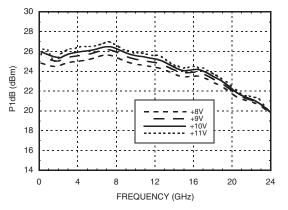




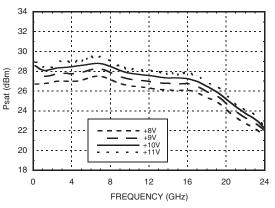


POWER AMPLIFIER, 0.2 - 22 GHz

P1dB vs. Vdd







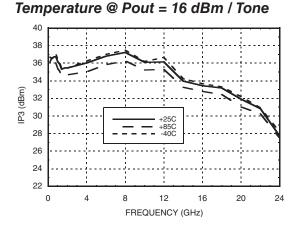
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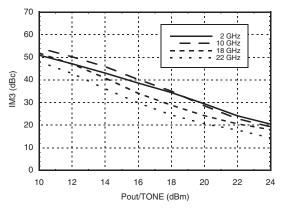
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ROHS

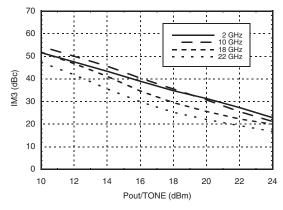
Output IP3 vs.



Output IM3 @ Vdd = 8V

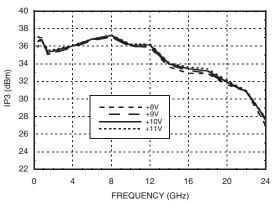


Output IM3 @ Vdd = 10V

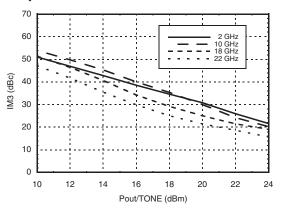


GaAs pHEMT MMIC POWER AMPLIFIER, 0.2 - 22 GHz

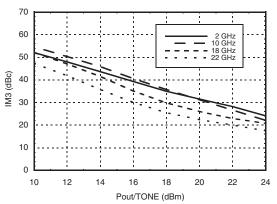
Output IP3 vs. Vdd @ Pout = 16 dBm / Tone



Output IM3 @ Vdd = 9V



Output IM3 @ Vdd = 11V



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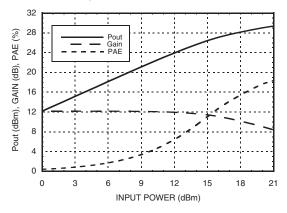


GaAs pHEMT MMIC

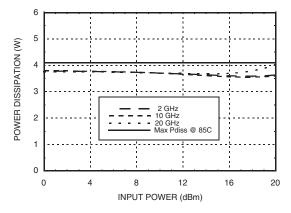
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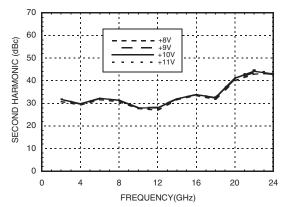
Power Compression @ 10 GHz



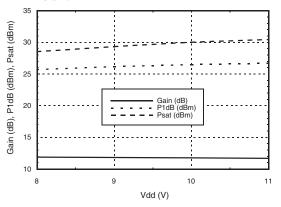
Power Dissipation



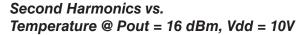
Second Harmonics vs. Vdd @ Pout = 16 dBm

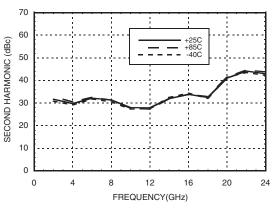


Gain & Power Supply vs. Supply Current @ 10 GHz

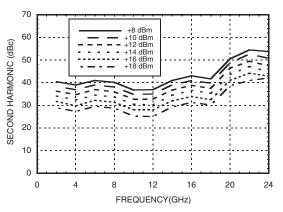


POWER AMPLIFIER, 0.2 - 22 GHz





Second Harmonics vs. Pout @ Vdd = 10V



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GaAs pHEMT MMIC

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Absolute Maximum Ratings

Drain Bias Voltage (Vdd)	+11 Vdc
RF Input Power (RFIN)(Vdd = +11V)	+20 dBm
Channel Temperature	150 °C
Continuous Pdiss (T= 85 °C) (derate 63 mW/°C above 85 °C)	4.1 W
Thermal Resistance (channel to ground paddle)	15.9 °C/W
Storage Temperature	-65 to 150°C
Operating Temperature	-55 to 85 °C
ESD Sensitivity (HBM)	Class 1A

Typical Supply Current vs. Vdd

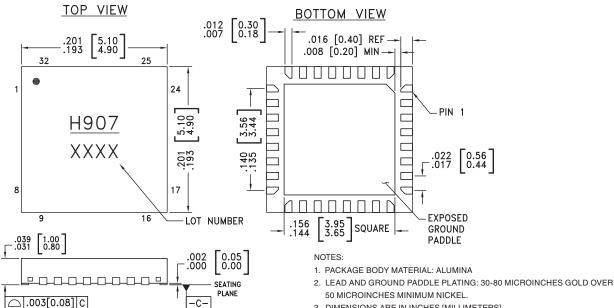
Vdd (V)	ldd (mA)
+8	335
+9	343
+10	350
+11	357

POWER AMPLIFIER, 0.2 - 22 GHz



ELECTROSTATIC SENSITIVE DEVICE **OBSERVE HANDLING PRECAUTIONS**

Outline Drawing



- 3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM -C-
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. CLASSIFIED AS MOISTURE SENSITIVITY LEVEL (MSL) 1.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[1]
HMC907LP5E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	<u>H907</u> XXXX

[1] 4-Digit lot number XXXX

[2] Max peak reflow temperature of 260 °C

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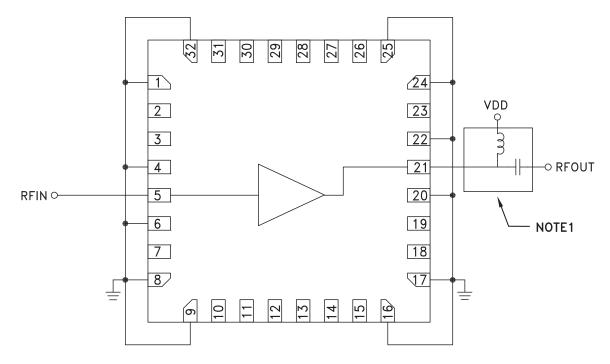


GaAs pHEMT MMIC POWER AMPLIFIER, 0.2 - 22 GHz

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 4, 6, 8, 9, 16, 17, 20, 22, 24, 25, 32	GND	Package bottom has exposed metal paddle that must be connected to RF/DC ground.	
2, 3, 7, 10 - 15, 18, 19, 23, 26 - 31	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
5	RFIN	This pin is DC coupled and matched to 50 Ohms. Blocking capacitor is required.	
21	RFOUT & Vdd	RF output for amplifier. Connect DC bias (Vdd) network to provide drain current (Idd). See application circuit herein.	RFOUT Vdd T

Application Circuit



NOTE 1: Drain Bias (Vdd) must be applied through a broadband bias tee or external bias network.

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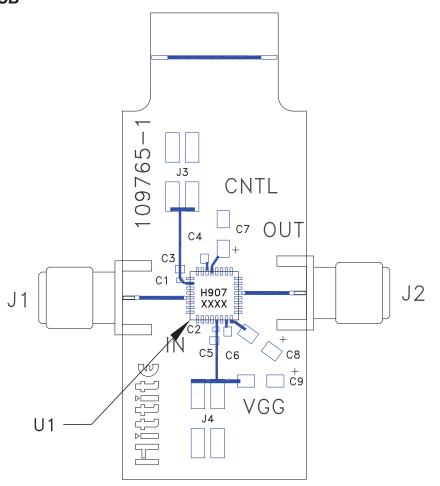
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HMC907LP5E

GaAs pHEMT MMIC POWER AMPLIFIER, 0.2 - 22 GHz



Evaluation PCB



List of Materials for Evaluation PCB 130812^[1]

Item	Description
J1, J2	SMA Connector
U1	HMC907LP5E Power Amplifier
PCB [2]	109765 Evaluation PCB

Reference this number when ordering complete evaluation PCB
Circuit Board Material: Rogers 4350 or Arlon FR4

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

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